

# APPROVAL SHEET

**RFCPL Series - 2012(0805) - RoHS Compliance**

**MULTILAYER CERAMIC COUPLER**

**Halogens Free Product**

**3300 ~ 3800 MHz Working Frequency**

**P/N: RFCPL20073G5W0T**

\*Contents in this sheet are subject to change without prior notice.

**FEATURES**

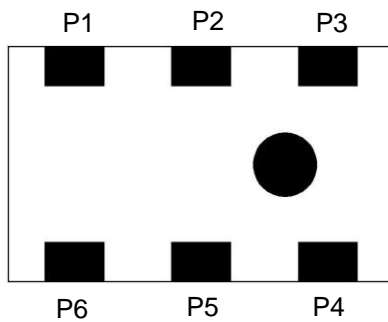
1. Miniature footprint: 2.0 X 1.25 X 0.7 mm<sup>3</sup>
2. Low Insertion Loss
3. LTCC process

**APPLICATIONS**

1. 3300 ~ 3800 MHz working frequency

**CONSTRUCTION**

Top view



| PIN | Connection |
|-----|------------|
| P1  | Input      |
| P2  | GND        |
| P3  | Isolated   |
| P4  | Direct     |
| P5  | GND        |
| P6  | Coupled    |

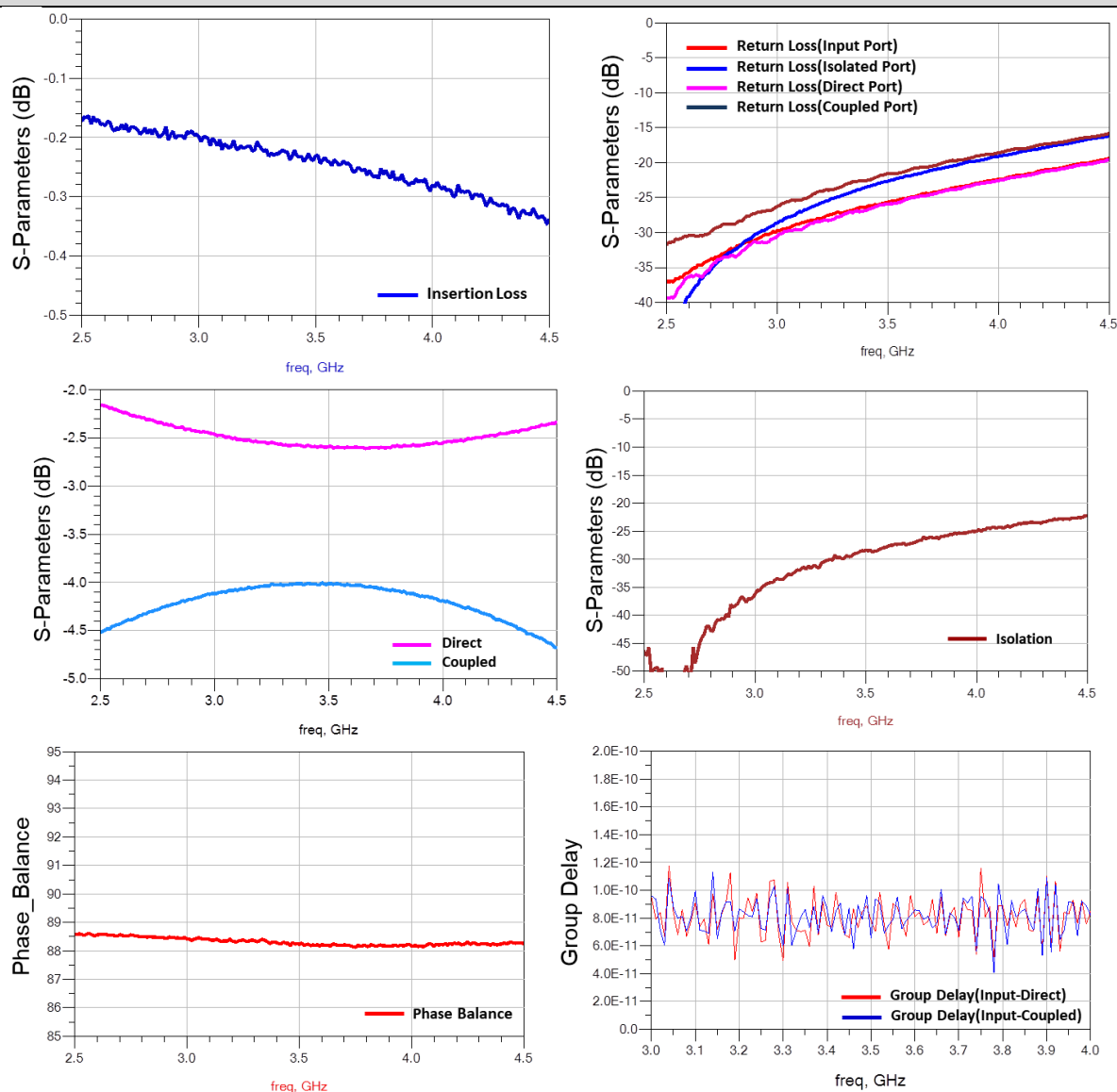
**DIMENSIONS**

| Figure          | Symbol | Dimension (mm) |
|-----------------|--------|----------------|
| <br>Top view    | L      | 2.00 ± 0.15    |
|                 | W      | 1.25 ± 0.15    |
|                 | T      | 0.70 ± 0.10    |
|                 | A      | 0.20 ± 0.20    |
|                 | B      | 0.30 ± 0.20    |
|                 | C      | 0.35 ± 0.20    |
| <br>Side view   | D      | 0.65 ± 0.20    |
|                 | E      | 0.20 ± 0.15    |
| <br>Bottom view |        |                |

**ELECTRICAL CHARACTERISTICS**

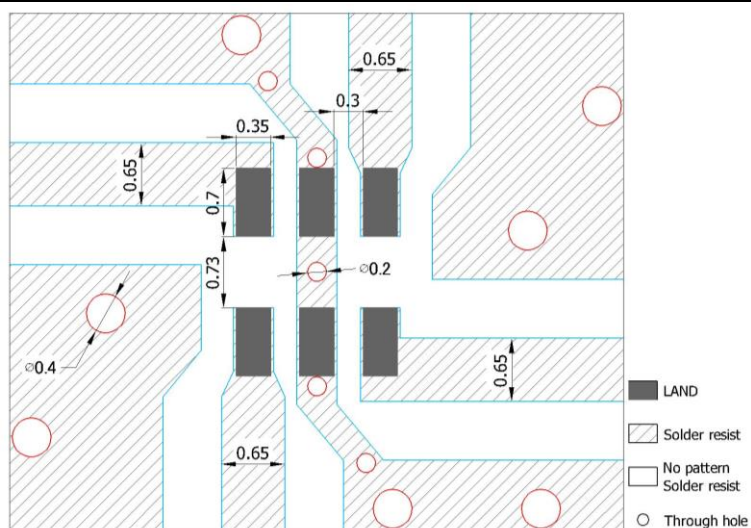
| <b>RFCPL20073G5W0T</b>   |         | <b>Specification</b>   |
|--|---------|--|
| Frequency range  |         | 3300 ~ 3800 MHz  |
| *Insertion Loss  |         | 0.40 dB max. (0.26 dB typ.) at -40 ~ +105°C<br>0.50 dB max. at +105 ~ +125°C |
| Direct   |         | 2.6 ± 0.6 dB (2.57 dB typ.)  |
| Coupling   |         | 4 ± 0.5 dB (4.1dB typ.)  |
| Return Loss  |         | 15 dB min.   |
| Isolation  |         | 18 dB min.   |
| Phase Balance  |         | 90 ± 5°  |
| Group delay(ns)  | Direct  | 0.08 ± 0.06ns  |
|  | Coupled |  |
| Port Impedance   |         | 50 Ω   |
| Power capacity   |         | 3W max.  |
| Moisture sensitivity levels  |         | LEVEL 1 (Refer to: IPC/JEDEC J-STD-020)                                      |
| HBM ESD  |         | Pass 1KV on all pins (Base on AEC-Q200-002)                                  |
| MM ESD   |         | Pass 200V (Base on EIA/JESD22-A115)  |
| *Calculate the <b>Insertion Loss</b> of coupler on the below power method formula.<br>$\text{Insertion Loss} = 10\log \times \left[ \frac{P_{in}}{P_{cou} + P_{dir}} \right]$ $P_{in} = \text{Power of Input port}, P_{dir} = \text{Power of Direct port}, P_{cou} = \text{Power of Coupled port}$ |         |  |
| <b>Operating &amp; Storage Condition (Component)</b><br>Operation Temperature Range: -40°C ~ +125°C<br>Storage Temperature Range: -40°C ~ +125°C   |         |  |
| <b>Storage Condition before Soldering (Included packaging material)</b><br>Storage Temperature Range: +5 ~ +40°C<br>Humidity: 30 to 70% relative humidity  |         |  |

## Typical Electrical Chart



## LAND PATTERN

Figure



Unit: mm

Line width to be designed to match  $50 \Omega$  characteristic impedance, depending on PCB material and thickness.

## RELIABILITY TEST

| Test item   | Test condition / Test method   | Specification   |
|---|--|---|
| Solderability<br>JIS C 0050-4.6<br>JESD22-B102D       | *Solder bath temperature : $235 \pm 5^{\circ}\text{C}$<br>*Immersion time : $2 \pm 0.5$ sec<br>Solder : Sn3Ag0.5Cu for lead-free   | At least 95% of a surface of each terminal electrode must be covered by fresh solder.   |
| Resistance to soldering heat<br>JIS C 0050-5.4        | *Preheating temperature : $120 \sim 150^{\circ}\text{C}$ , 1 minute.<br>*Solder temperature : $270 \pm 5^{\circ}\text{C}$<br>*Immersion time : $10 \pm 1$ sec<br>Solder : Sn3Ag0.5Cu for lead-free<br>Measurement to be made after keeping at room temperature for $24 \pm 2$ hrs                  | No mechanical damage.<br>Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$ .<br>Loss of metallization on the edges of each electrode shall not exceed 25%. |
| Drop Test<br>JIS C 0044<br>Customer's specification.  | *Height : 75 cm<br>*Test Surface : Rigid surface of concrete or steel.<br>*Times : 6 surfaces for each units ; 2 times for each side.  | No mechanical damage.<br>Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$ .   |
| Vibration<br>JIS C 0040                               | *Frequency : $10\text{Hz} \sim 55\text{Hz} \sim 10\text{Hz}(1\text{min})$<br>*Total amplitude : 1.5mm<br>*Test times : 6hrs.(Two hrs each in three mutually perpendicular directions)  | No mechanical damage.<br>Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$ .   |
| Adhesive Strength of Termination<br>JIS C 0051- 7.4.3 | *Pressurizing force :<br>5N (LGA terminal series) for 10 sec ;<br>5N ( $\leq 1608$ ) for 10 sec ;<br>10N ( $> 1608$ ) for 10 sec.  | No remarkable damage or removal of the termination.   |
| Bending test<br>JIS C 0051- 7.4.1                     | The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm and then pressure shall be maintained for $5 \pm 1$ sec.<br>Measurement to be made after keeping at room temperature for $24 \pm 2$ hours | No mechanical damage.<br>Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$ .   |

|   |  |   |
|---|--|---|
| Temperature cycle<br>JIS C 0025               | 1. 30±3 minutes at -40°C±3°C,<br>2. 10~15 minutes at room temperature,<br>3. 30±3 minutes at +85°C±3°C,<br>4. 10~15 minutes at room temperature,<br>Total 100 continuous cycles<br>Measurement to be made after keeping at room temperature for 24±2 hrs | No mechanical damage.<br>Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C. |
| High temperature<br>JIS C 0021                | *Temperature : 85°C±2°C<br>*Test duration : 1000+24/-0 hours<br>Measurement to be made after keeping at room temperature for 24±2 hrs  | No mechanical damage.<br>Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C. |
| Humidity<br>(steady conditions)<br>JIS C 0022 | *Humidity : 90% to 95% R.H.<br>*Temperature : 40±2°C<br>*Time : 1000+24/-0 hrs.<br>Measurement to be made after keeping at room temperature for 24±2 hrs<br>※ 500hrs measuring the first data then 1000hrs data  | No mechanical damage.<br>Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C. |
| Low temperature<br>JIS C 0020                 | *Temperature : -40°C±2°C<br>*Test duration : 1000+24/-0 hours<br>Measurement to be made after keeping at room temperature for 24±2 hrs   | No mechanical damage.<br>Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C. |

## SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,  
 This product could sustain by reflow process three times, and the temperature below 260°C.

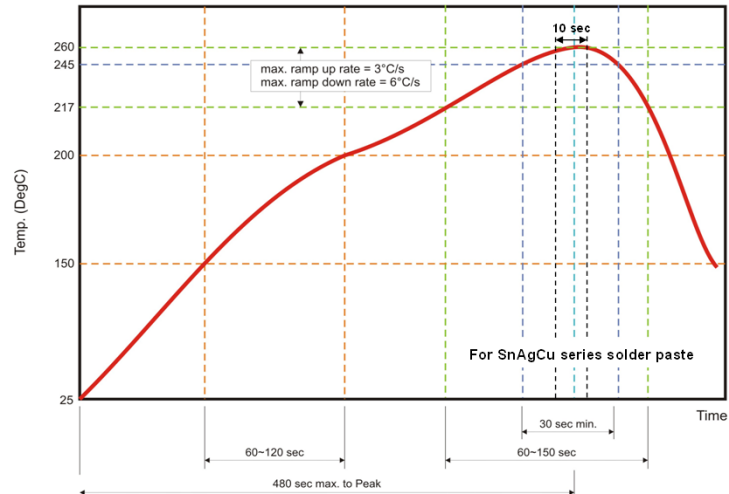


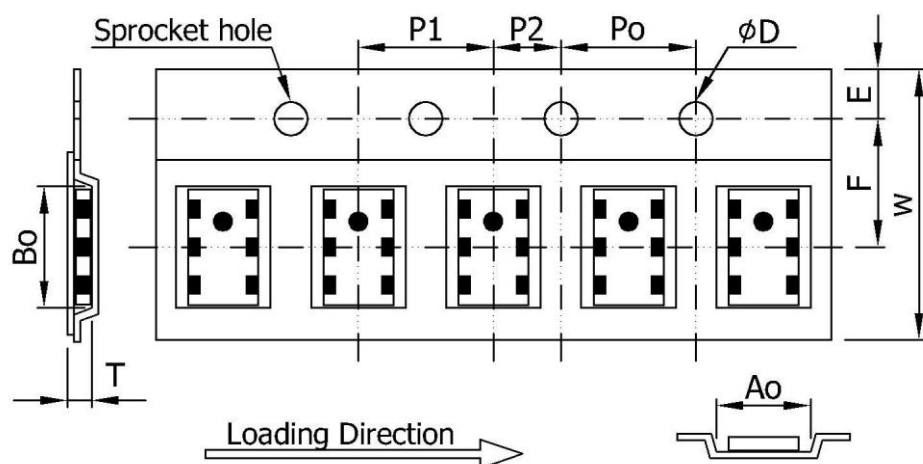
Fig 2. Infrared soldering profile

## ORDERING CODE

| RF                  | CPL                             | 2007   | 3G5                                  | W                                  | 0                            | T                     |
|---------------------|---------------------------------|--|--------------------------------------|------------------------------------|------------------------------|-----------------------|
| Walsin<br>RF device | Product<br>Code<br>CPL: Coupler | Dimension code<br>Per 2 digits of Length, Width,<br>Thickness :<br>e.g. :<br>20 =<br>Length 2.0 mm,<br>Width 1.25 mm.<br>07 =<br>Thickness 0.7 mm. | Central<br>Frequency<br>3G5: 3.5 GHz | Application<br>W:<br>3300~3800 MHz | Specification<br>Design Code | Packing<br>T : Reeled |

Minimum Ordering Quantity: 4000 pcs per reel.

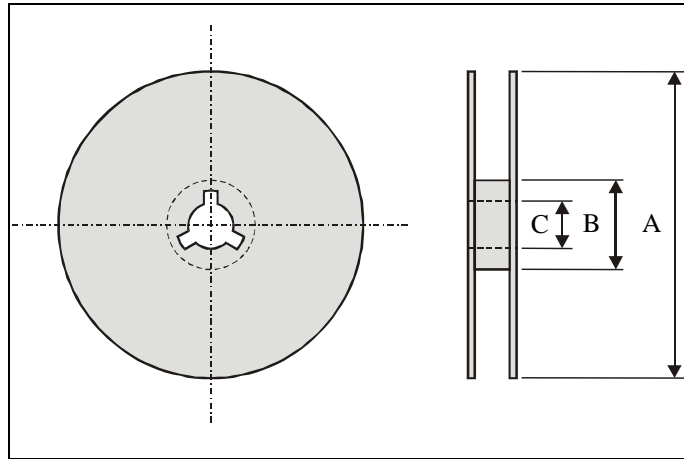
## PACKAGING



Black Conductive Tape specifications (unit: mm)

| Index          | Ao              | Bo              | $\Phi D$        | T               | W               |
|----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| Dimension (mm) | $1.40 \pm 0.10$ | $2.25 \pm 0.10$ | $1.55 \pm 0.05$ | $0.75 \pm 0.10$ | $8.00 \pm 0.10$ |
| Index          | E               | F               | Po              | P1              | P2              |
| Dimension (mm) | $1.75 \pm 0.10$ | $3.50 \pm 0.05$ | $4.00 \pm 0.10$ | $2.00 \pm 0.05$ | $2.00 \pm 0.05$ |

## Reel dimensions



| Index          | A      | B     | C     |
|----------------|--------|-------|-------|
| Dimension (mm) | Φ178.0 | Φ60.0 | Φ13.0 |

Taping Quantity: 4000 pieces per 7" reel

## CAUTION OF HANDLING

## Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

## Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection.
- (2) Storage environment condition.
  - Products should be storage in the warehouse on the following conditions.
  - Temperature : +5 to +40℃
  - Humidity : 30 to 70% relative humidity
  - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
  - Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
  - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
  - Products should be storage under the airtight packaged condition.